Vishay Semiconductors

Thyristor Surface Mount, Phase Control SCR, 8 A



TO-263AB	(D ² PAK)
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PRODUCT SUMMARY							
Package	TO-263AB (D ² PAK)						
Diode variation	Single SCR						
I _{T(AV)}	8 A						
V _{DRM} /V _{RRM}	800 V						
V _{TM}	1.2 V						
I _{GT}	15 mA						
TJ	-40 to +125 °C						

FEATURES

- J-STD-020, Meets MSL level 1, per LF maximum peak of 260 °C
- Designed and qualified according JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Input rectification and crow-bar (soft start)
- · Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-12TTS08SPbF High Voltage Series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS								
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS								
Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C, common heatsink of 1 °C/W	13.5	17	А					

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	8	А						
I _{T(RMS)}		12.5	A						
V _{RRM} /V _{DRM}		800	V						
I _{TSM}		110	А						
V _T	8 A, T _J = 25 °C	1.2	V						
dV/dt		150	V/µs						
dl/dt		100	A/µs						
TJ	Range	-40 to +125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} ∕I _{DRM} AT 125 °C mA						
VS-12TTS08SPbF	800	800	1.0						

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HALOGEN

FREE





VS-12TTS08SPbF Series

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PARAMETER	SYMBOL		TEST CONDITIONS	VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	T 100.00			
Maximum RMS on-state current	I _{T(RMS)}	$I_{\rm C} = 108 {}^{\circ}{\rm C},$	180° conduction, half sine wave	12.5	<u>^</u>
Maximum peak one-cycle		10 ms sine pu	llse, rated V_{RRM} applied, $T_J = 125 \text{ °C}$	95	A
non-repetitive surge current	I _{TSM}	10 ms sine pu	Ilse, no voltage reapplied, $T_J = 125 \ ^{\circ}C$	110	
Maximum 12t for fueing	l ² t	10 ms sine pu	llse, rated V_{RRM} applied, $T_J = 125 \text{ °C}$	45	A ² s
Maximum I ² t for fusing	I ² T	10 ms sine pu	Ilse, no voltage reapplied, $T_J = 125 \ ^{\circ}C$	64	A²S
Maximum $I^2 \sqrt{t}$ for fusing	l²√t	t = 0.1 ms to 1	640	A²√s	
Maximum on-state voltage drop	V _{TM}	8 A, T _J = 25 °	1.2	V	
On-state slope resistance	r _t			16.2	mΩ
Threshold voltage	V _{T(TO)}	T _J = 125 °C		0.87	V
Maximum reverse and direct lockage current	1 /1	T _J = 25 °C		0.05	
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	T _J = 125 °C	V _R = Rated V _{RRM} /V _{DRM}	1.0	
Typical holding current	Ι _Η	Anode supply = 6 V, resistive load, initial I_T = 1 A, T _J = 25 °C		30	mA
Maximum latching current	١L	Anode supply	50		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J max., $	150	V/µs	
Maximum rate of rise of turned-on current	dl/dt			100	A/µs

TRIGGERING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum peak gate power	P _{GM}		8.0	W			
Maximum average gate power	P _{G(AV)}		2.0	vv			
Maximum peak positive gate current	+ I _{GM}		1.5	А			
Maximum peak negative gate voltage	- V _{GM}		10	V			
	I _{GT}	Anode supply = 6 V, resistive load, T_J = - 65 °C	20	mA			
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, $T_J = 25 \text{ °C}$	15				
		Anode supply = 6 V, resistive load, $T_J = 125 \text{ °C}$	10				
		Anode supply = 6 V, resistive load, T_J = - 65 °C	1.2				
Maximum required DC gate voltage to trigger	V _{GT}	Anode supply = 6 V, resistive load, $T_J = 25 \degree C$	1	N			
		Anode supply = 6 V, resistive load, T_J = 125 °C	0.7	V			
Maximum DC gate voltage not to trigger	V _{GD}	T 105 °C V Dated volue	0.2				
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value	0.1	mA			

SWITCHING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Typical turn-on time	t _{gt}	$T_J = 25 \ ^{\circ}C$	0.8				
Typical reverse recovery time	t _{rr}	T.I = 125 °C	3	μs			
Typical turn-off time	tq	ij=125 C	100				

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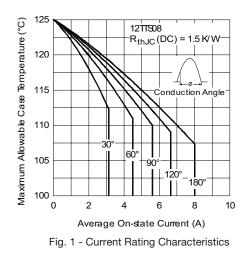
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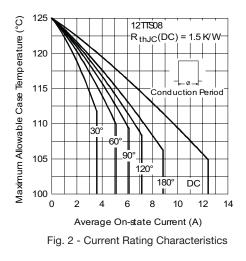
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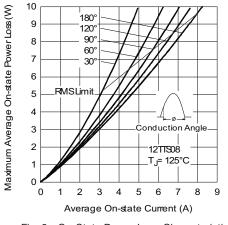


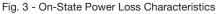
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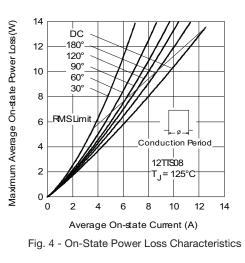
THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range		T _J , T _{Stg}		-40 to +125	°C			
Maximum thermal resistance, junction to case		R _{thJC}	DC operation	1.5				
Maximum thermal resistance, junction to ambient		R _{thJA}		62	°C/W			
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.5				
Approvimete weight				2	g			
Approximate weight				0.07	oz.			
Mounting torque	minimum			6 (5)	kgf ⋅ cm			
Mounting torque —	maximum			12 (10)	(lbf · in)			
Marking device			Case style D ² PAK (SMD-220)	12TT	S08S			











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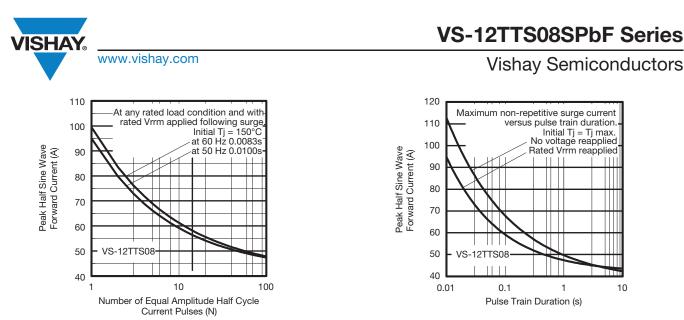
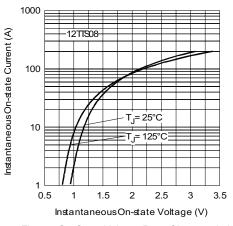


Fig. 5 - Maximum Non-Repetitive Surge Current

Fig. 6 - Maximum Non-Repetitive Surge Current





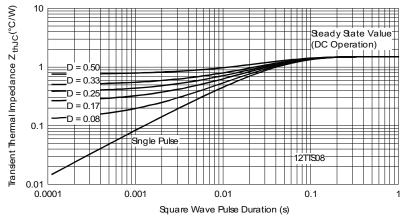
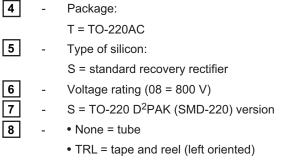


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

T = single thyristor Package:



• TRR = tape and reel (right oriented)

- PbF = lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-12TTS08SPbF	50	1000	Antistatic plastic tubes					
VS-12TTS08STRRPbF	800	800	13" diameter reel					
VS-12TTS08STRLPbF	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95046					
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					

PbF

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ORDERING INFORMATION TABLE

Device code

VS-

(1)

1

2

3

9

12

(2)

Т

(3)

Т

(4)

Vishay Semiconductors product

Current rating (12.5 A)

Circuit configuration:

S

(5)

08

(6)

S

(7

TRL

(8)

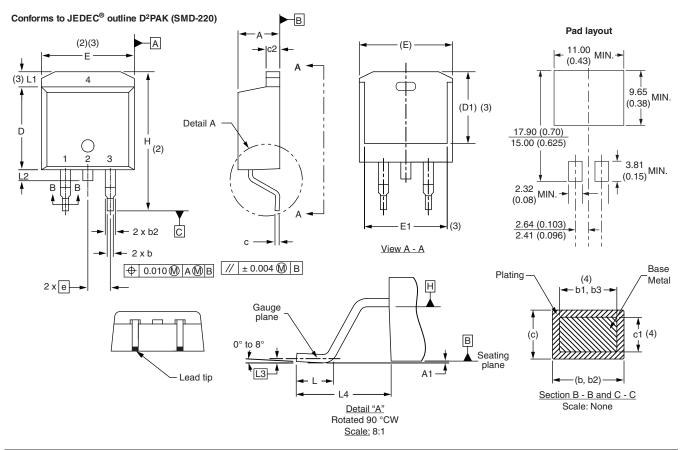
Outline Dimensions



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIN	ETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	STINDUL	MIN.	MAX.	MIN.	MAX.	NOTES	
А	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010) BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Datum A and B to be determined at datum plane H

⁽⁶⁾ Controlling dimension: inch

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-263AB

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